

SN54LS592, SN54LS593, SN74LS592, SN74LS593 8-BIT BINARY COUNTERS WITH INPUT REGISTERS

SDLS004

D2633, JANUARY 1981 — REVISED MARCH 1988

- Parallel Register Inputs ('LS592)
- Parallel 3-State I/O: Register Inputs/Counter Outputs ('LS593)
- Counter has Direct Overriding Load and Clear
- Accurate Counter Frequency: DC to 20 MHz

description

The 'LS592 comes in a 16-pin package and consists of a parallel input, 8-bit storage register feeding an 8-bit binary counter. Both the register and the counter have individual positive-edge-triggered clocks. In addition, the counter has direct load and clear functions. A low-going \overline{RCO} pulse will be obtained when the counter reaches the hex word FF. Expansion is easily accomplished for two stages by connecting \overline{RCO} of the first stage to \overline{CCKEN} of the second stage. Cascading for larger count chains can be accomplished by connecting \overline{RCO} of each stage to CCK of the following stage.

The 'LS593 comes in a 20-pin package and has all the features of the 'LS592 plus 3-state I/O, which provides parallel counter outputs. The tables below show the operation of the enable (CCKEN, \overline{CCKEN}) inputs. A register clock enable (RCKEN) is also provided.

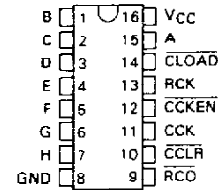
OUTPUT ENABLE CONTROL ('593 ONLY)

| G | \overline{G} | A/Q _A thru H/Q _H |
|---|----------------|--|
| L | L | input mode |
| L | H | input mode |
| H | L | output mode |
| H | H | input mode |

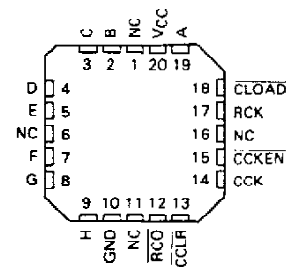
COUNTER CLOCK ENABLE CONTROL

| CCKEN | \overline{CCKEN} | EFFECT ON CCK |
|-------|--------------------|---------------|
| L | L | Enable |
| L | H | Disable |
| H | L | Enable |
| H | H | Enable |

SN54LS592 . . . J OR W PACKAGE SN74LS592 . . . N PACKAGE (TOP VIEW)

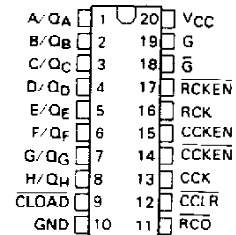


SN54LS592 . . . FK PACKAGE (TOP VIEW)

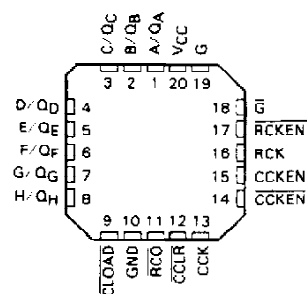


NC — No internal connection

SN54LS593 . . . J OR W PACKAGE SN74LS593 . . . DW OR N PACKAGE (TOP VIEW)



SN54LS593 . . . FK PACKAGE (TOP VIEW)



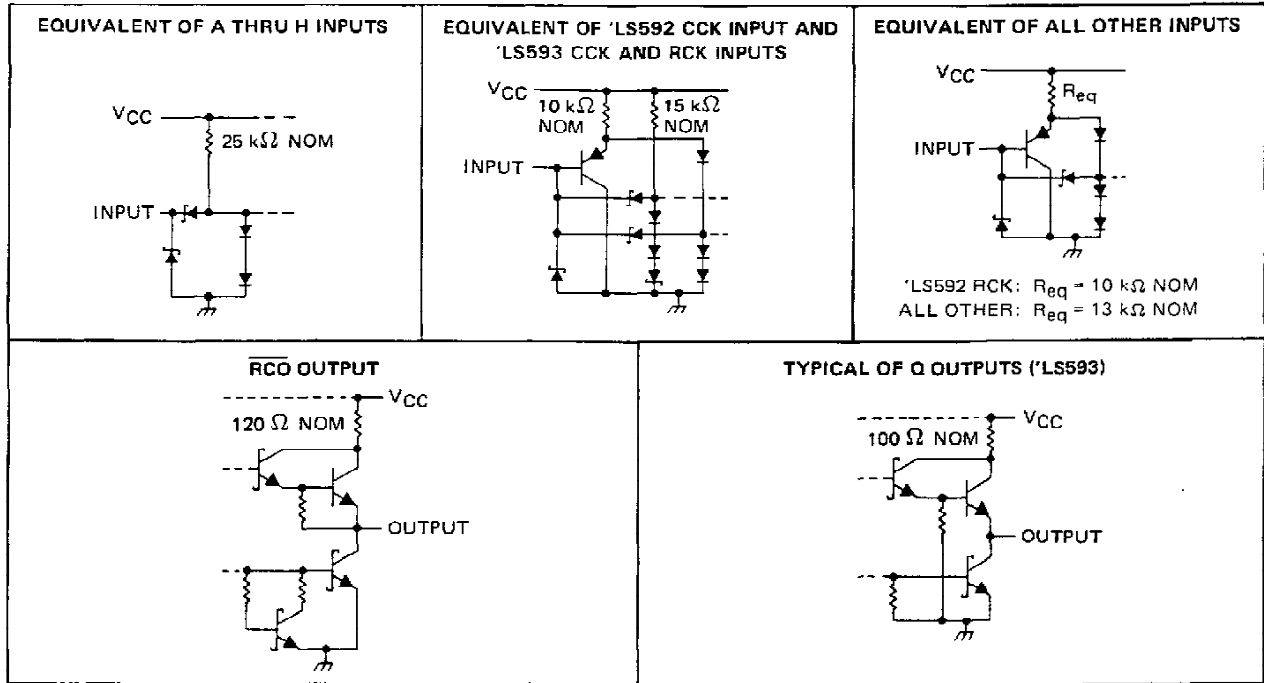
PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
INSTRUMENTS

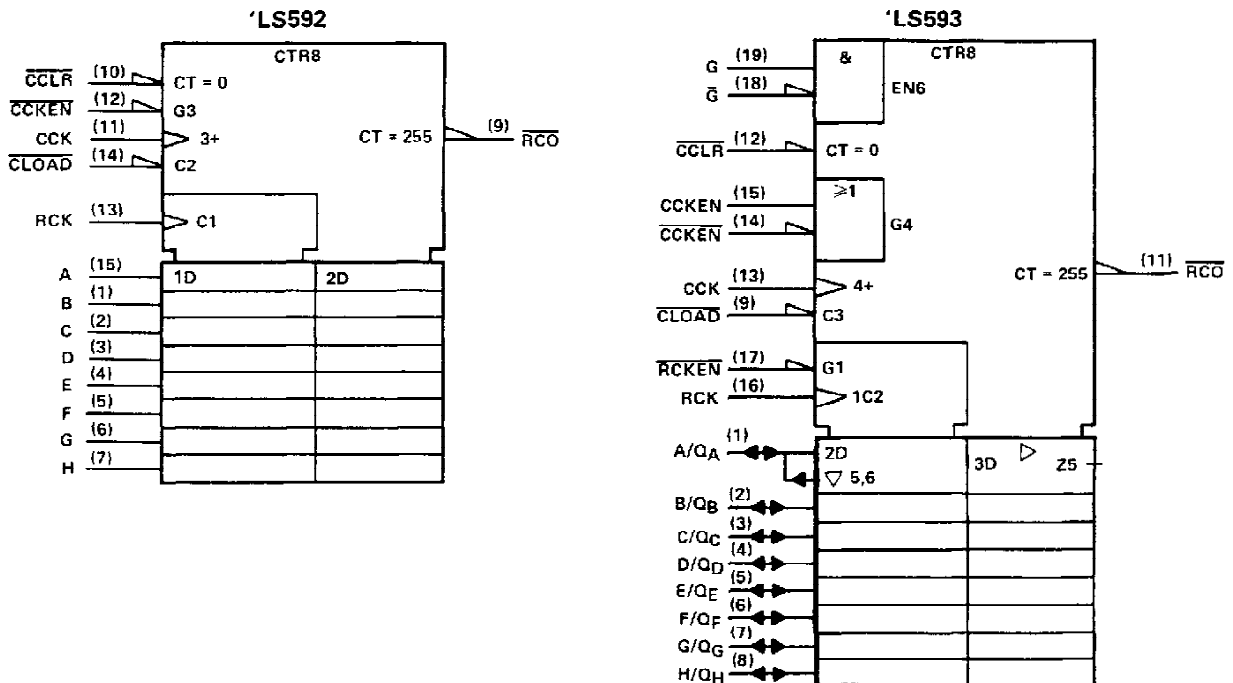
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SN54LS592, SN54LS593, SN74LS592, SN74LS593 8-BIT BINARY COUNTERS WITH INPUT REGISTERS

schematics of inputs and outputs



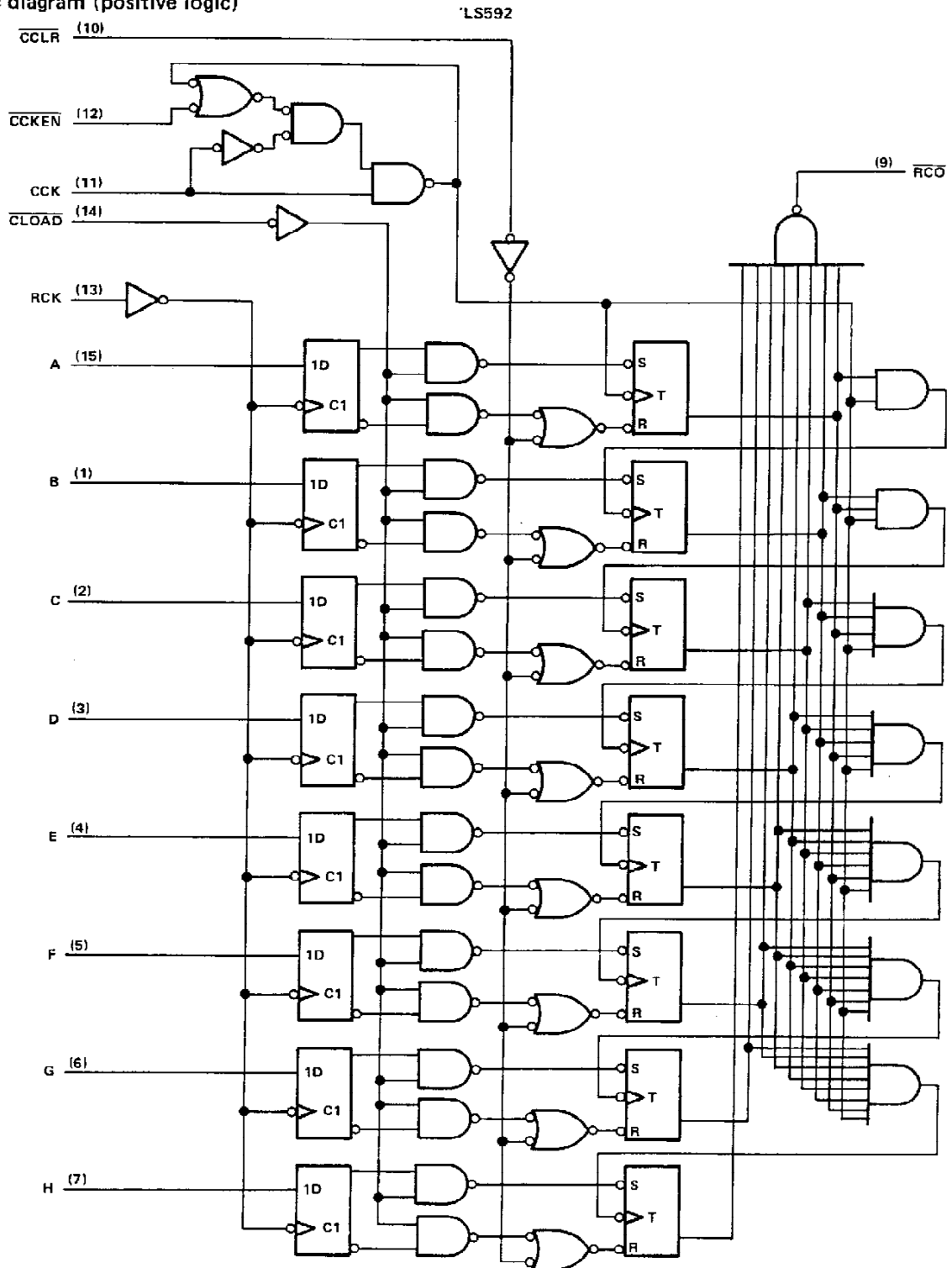
logic symbols †



† These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for DW, J, N, and W packages.

SN54LS592, SN74LS592 8-BIT BINARY COUNTERS WITH INPUT REGISTERS

logic diagram (positive logic)

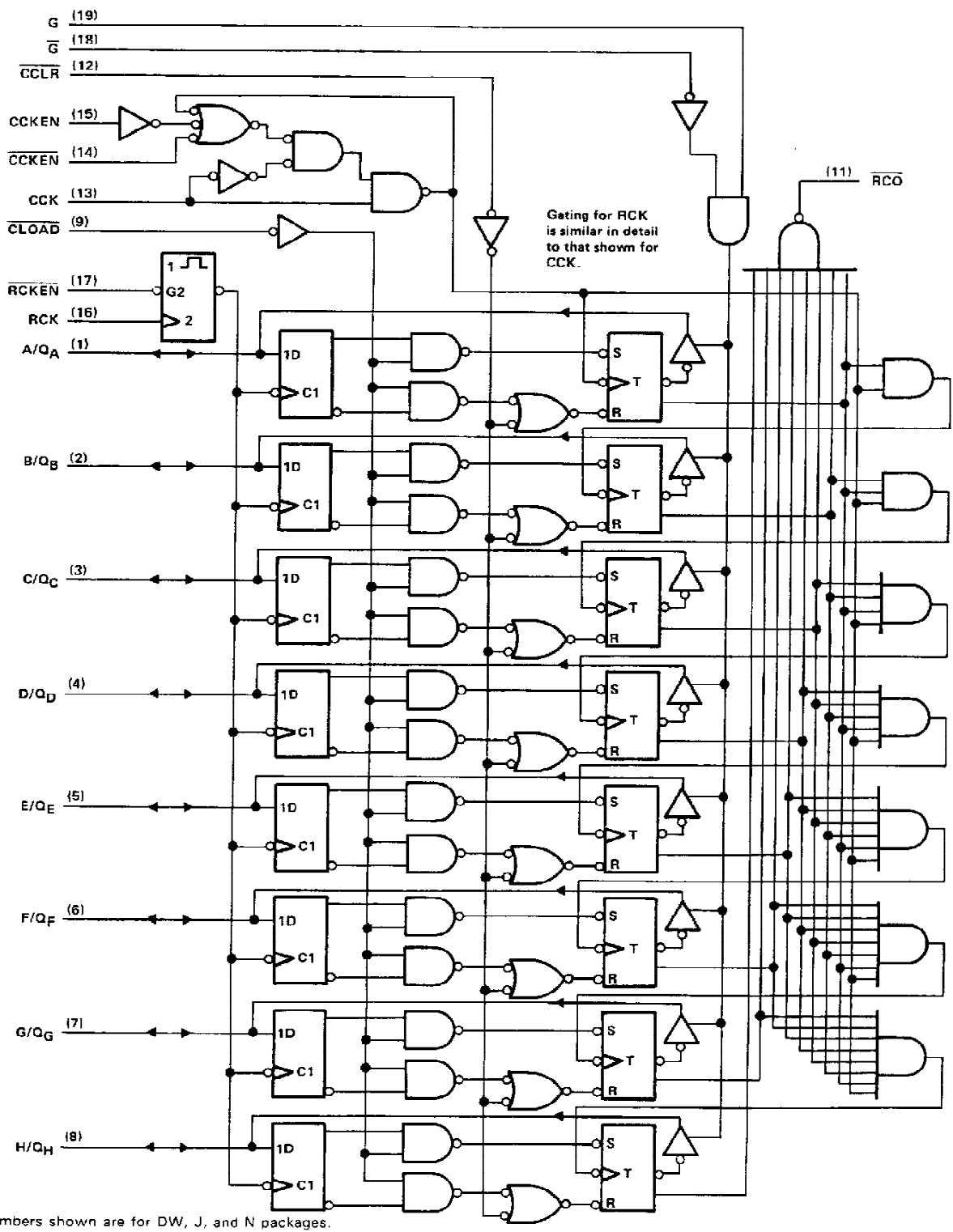


Pin numbers shown are for J, N, and W packages.

SN54LS593, SN74LS593 8-BIT BINARY COUNTERS WITH INPUT REGISTERS

Logic diagram (positive logic)

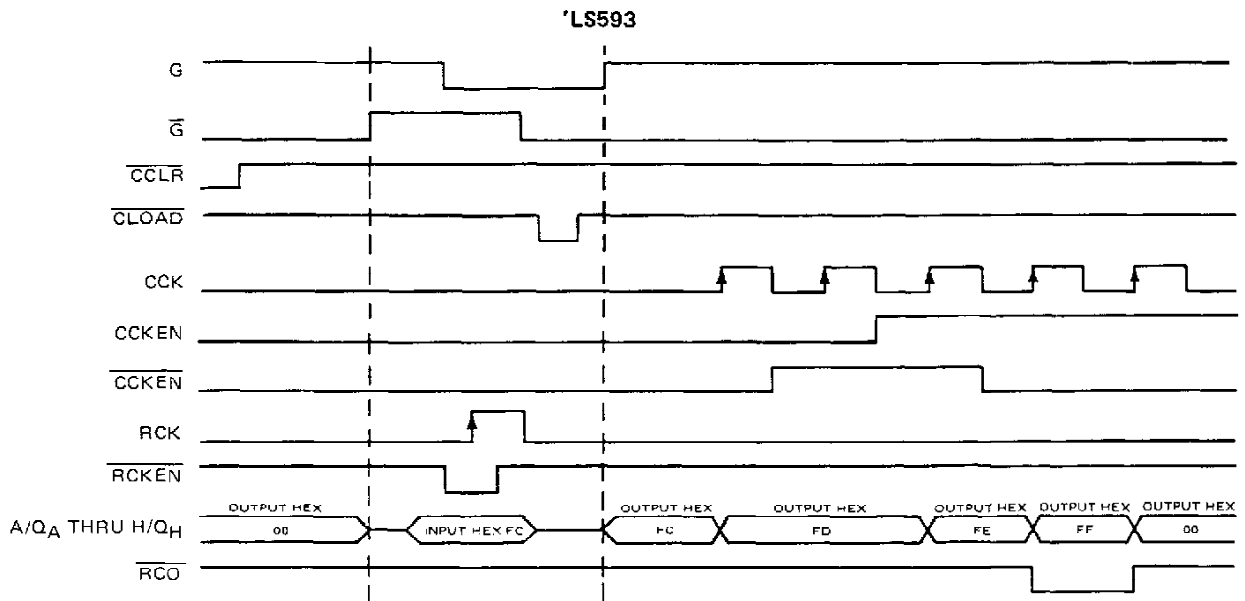
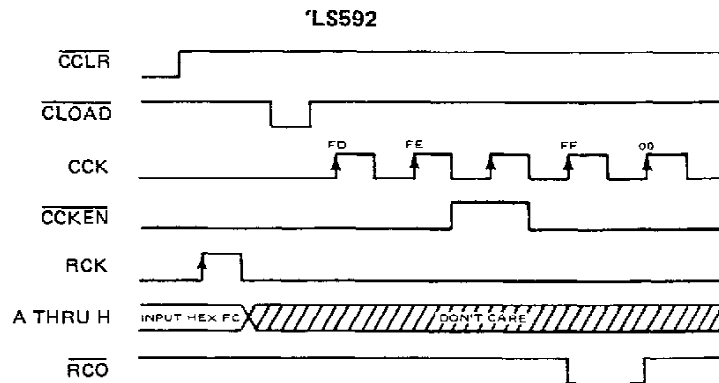
'LS593



Pin numbers shown are for DW, J, and N packages.

SN54LS592, SN54LS593, SN74LS592, SN74LS593
8-BIT BINARY COUNTERS WITH INPUT REGISTERS

typical operating sequences



SN54LS592, SN54LS593, SN74LS592, SN74LS593

8-BIT BINARY COUNTERS WITH INPUT REGISTERS

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| | |
|--|----------------|
| Supply voltage, V_{CC} (see Note 1) | 7 V |
| Input voltage (excluding I/O ports) | 7 V |
| Off-state output voltage (including I/O ports) | 5.5 V |
| Operating free-air temperature range: SN54LS592, SN54LS593 | -55°C to 125°C |
| SN74LS592, SN74LS593 | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

NOTE 1: Voltage values are with respect to the network ground terminal.

recommended operating conditions

| | | SN54LS' | | | SN74LS' | | | UNIT |
|-------------------------|--|---|-----|-----|---|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| V_{IH} | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.7 | | | 0.8 | V |
| I_{OH} | High-level output current | \overline{RCK} | | -1 | \overline{RCK} | | -1 | mA |
| | | Q 'LS593 only | | -1 | Q 'LS593 only | | -2.6 | |
| I_{OL} | Low-level output current | \overline{RCK} | | 8 | \overline{RCK} | | 16 | mA |
| | | Q 'LS593 only | | 12 | Q 'LS593 only | | 24 | |
| f_{CCK} | Counter clock frequency | 0 | | 20 | 0 | | 20 | MHz |
| $t_w(\overline{CCK})$ | Duration of counter clock pulse | 25 | | | 25 | | | ns |
| $t_w(\overline{CCLR})$ | Duration of counter clear pulse | 20 | | | 20 | | | ns |
| $t_w(\overline{RCK})$ | Duration of register clock pulse | 20 | | | 20 | | | ns |
| $t_w(\overline{CLOAD})$ | Duration of counter load pulse | 40 | | | 40 | | | ns |
| t_{su} | Register enable setup time | \overline{RCKEN} low to $\overline{RCK} \uparrow$, 'LS593 | | 20 | \overline{RCKEN} low to $\overline{RCK} \uparrow$, 'LS593 | | 20 | ns |
| t_{su} | Counter enable setup time before $\overline{CCK} \uparrow$ | \overline{CCKEN} low, 'LS592 | | 30 | \overline{CCKEN} low, 'LS592 | | 30 | ns |
| | | \overline{CCKEN} low or \overline{CCKEN} high, 'LS593 | | 30 | \overline{CCKEN} low or \overline{CCKEN} high, 'LS593 | | 30 | |
| | | \overline{CCLR} inactive before $\overline{CCK} \uparrow$ | | 20 | \overline{CCLR} inactive before $\overline{CCK} \uparrow$ | | 20 | |
| t_{su} | Setup time | \overline{CLOAD} inactive before $\overline{CCK} \uparrow$ | | 20 | \overline{CLOAD} inactive before $\overline{CCK} \uparrow$ | | 20 | ns |
| | | $\overline{RCK} \uparrow$ before $\overline{CLOAD} \uparrow$ (see Note 2) | | 30 | $\overline{RCK} \uparrow$ before $\overline{CLOAD} \uparrow$ (see Note 2) | | 30 | |
| | | Data A thru H before $\overline{RCK} \uparrow$ | | 20 | Data A thru H before $\overline{RCK} \uparrow$ | | 20 | |
| | | Data A thru H after $\overline{RCK} \uparrow$ | | 0 | Data A thru H after $\overline{RCK} \uparrow$ | | 0 | |
| t_h | Hold time | Data A thru H after $\overline{RCK} \uparrow$ | | 0 | Data A thru H after $\overline{RCK} \uparrow$ | | 0 | ns |
| | | All others | | 0 | All others | | 0 | |
| T_A | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

NOTE 2: This time insures the data saved by $\overline{RCK} \uparrow$ will also be loaded into the counter.



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SN54LS592, SN54LS593, SN74LS592, SN74LS593 8-BIT BINARY COUNTERS WITH INPUT REGISTERS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS [†] | SN54LS [*] | | SN74LS [*] | | UNIT | | | |
|---------------|--|--|-------------------------------|-----------------------|------|------|------------------|------|-----|
| | | MIN | TYP [‡] | MAX | MIN | | TYP [‡] | MAX | |
| V_{IK} | $V_{CC} = \text{MIN.}$, $I_I = -18 \text{ mA}$ | | | -1.5 | | -1.5 | V | | |
| V_{OH} | 'LS593 Q $V_{CC} = \text{MIN.}$, $V_{IH} = 2 \text{ V.}$ $V_{IL} = \text{MAX.}$ | $I_{OH} = -1 \text{ mA}$ | | 2.4 | 3.2 | | V | | |
| | | $I_{OH} = -2.6 \text{ mA}$ | | | | 2.4 | | 3.1 | |
| | | $I_{OH} = -1 \text{ mA}$ | | 2.4 | 3.2 | 2.4 | | 3.2 | |
| V_{OL} | 'LS593 Q $V_{CC} = \text{MIN.}$, $V_{IH} = 2 \text{ V.}$ $V_{IL} = \text{MAX.}$ | $I_{OL} = 12 \text{ mA}$ | | | 0.25 | 0.4 | V | | |
| | | $I_{OL} = 24 \text{ mA}$ | | | | 0.35 | | 0.5 | |
| | | $I_{OL} = 8 \text{ mA}$ | | | 0.25 | 0.4 | | 0.25 | 0.4 |
| | | $I_{OL} = 16 \text{ mA}$ | | | | 0.35 | | 0.5 | |
| I_{OZH} | 'LS593 Q $V_{CC} = \text{MAX.}$, $V_{IH} = 2 \text{ V.}$ $V_O = 2.7 \text{ V}$ | $V_{IL} = \text{MAX.}$ | | | | 20 | μA | | |
| I_{OZL} | 'LS593 Q $V_{CC} = \text{MAX.}$, $V_{IH} = 2 \text{ V.}$ $V_O = 0.4 \text{ V}$ | $V_{IL} = \text{MAX.}$ | | | | -0.4 | mA | | |
| I_I | 'LS593 Q Others | $V_{CC} = \text{MAX.}$ | | $V_I = 5.5 \text{ V}$ | | 0.1 | mA | | |
| | | | | $V_I = 7 \text{ V}$ | | 0.1 | | | |
| I_{IH} | $V_{CC} = \text{MAX.}$, $V_I = 2.7 \text{ V}$ | | | | | 20 | μA | | |
| I_{IL} | CCK | $V_{CC} = \text{MAX.}$, $V_I = 0.4 \text{ V}$ | | | | -0.8 | mA | | |
| | RCK | | | 'LS592 | | | | -0.2 | |
| | | | | 'LS593 | | | | -0.8 | |
| | A thru H | | | | | -0.4 | | -0.4 | |
| | Others | | | | | -0.2 | | -0.2 | |
| I_{OS}^{\S} | 'LS593 Q | $V_{CC} = \text{MAX.}$, $V_O = 0 \text{ V}$ | | -30 | -130 | -30 | -130 | mA | |
| | $\overline{\text{RCO}}$ | | | -20 | -100 | -20 | -100 | | |
| I_{CC} | 'LS592 | I_{CCH} | $V_{CC} = \text{MAX.}$ | | 40 | 60 | 40 | 60 | mA |
| | | I_{CCL} | All possible inputs grounded, | | 40 | 60 | 40 | 60 | |
| | 'LS593 | I_{CCH} | All outputs open | | 47 | 70 | 47 | 70 | |
| | | I_{CCL} | | | 53 | 80 | 53 | 80 | |
| | | I_{CCZ} | | | 57 | 85 | 57 | 85 | |

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

[§]Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

TEXAS 
INSTRUMENTS

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SN54LS592, SN54LS593, SN74LS592, SN74LS593
8-BIT BINARY COUNTERS WITH INPUT REGISTERS

switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$, (see note 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | 'LS592 | | | 'LS593 | | | UNIT |
|-----------|----------------------|------------------|---|--------|-----|-----|--------|-----|-----|------|
| | | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| f_{max} | CCK ↑ | \overline{RCO} | $R_L = 1\text{ k}\Omega$, $C_L = 30\text{ pF}$ | 20 | 35 | | 20 | 35 | | MHz |
| t_{PLH} | CCK ↑ | Q | $R_L = 667\ \Omega$, $C_L = 45\text{ pF}$ | | | | 14 | 21 | | ns |
| t_{PHL} | CCK ↑ | Q | | | | | 26 | 39 | | ns |
| t_{PLH} | \overline{CLOAD} ↓ | Q | | | | | 34 | 51 | | ns |
| t_{PHL} | \overline{CLOAD} ↓ | Q | | | | | 28 | 42 | | ns |
| t_{PHL} | \overline{CCLR} ↓ | Q | | | | | 25 | 38 | | ns |
| t_{PZH} | G ↑ | Q | | | | | 31 | 47 | | ns |
| t_{PZL} | G ↑ | Q | | | | | 27 | 40 | | ns |
| t_{PZH} | \overline{G} ↓ | Q | | | | | 29 | 45 | | ns |
| t_{PZL} | \overline{G} ↓ | Q | | | | | 31 | 47 | | ns |
| t_{PHZ} | G ↓ | Q | | | | | 33 | 50 | | ns |
| t_{PLZ} | G ↓ | Q | $R_L = 667\ \Omega$, $C_L = 5\text{ pF}$ | | | | 35 | 52 | | ns |
| t_{PHZ} | \overline{G} ↑ | Q | | | | | 26 | 39 | | ns |
| t_{PLZ} | \overline{G} ↑ | Q | | | | | 28 | 42 | | ns |
| t_{PLH} | CCK ↑ | \overline{RCO} | | | | | | | | |
| t_{PHL} | CCK ↑ | \overline{RCO} | $R_L = 1\text{ k}\Omega$, $C_L = 30\text{ pF}$ | 15 | 23 | | 14 | 21 | | ns |
| t_{PLH} | \overline{CLOAD} ↓ | \overline{RCO} | | 20 | 30 | | 20 | 30 | | ns |
| t_{PHL} | \overline{CLOAD} ↓ | \overline{RCO} | | 31 | 47 | | 31 | 47 | | ns |
| t_{PLH} | \overline{CCLR} ↓ | \overline{RCO} | | 27 | 41 | | 27 | 41 | | ns |
| t_{PHL} | \overline{CCLR} ↓ | \overline{RCO} | | 30 | 45 | | 30 | 45 | | ns |
| t_{PLH} | RCK ↑ | \overline{RCO} | $R_L = 1\text{ k}\Omega$; $C_L = 30\text{ pF}$ $\overline{CLOAD} = L$ | 35 | 53 | | 42 | 63 | | ns |
| t_{PHL} | RCK ↑ | \overline{RCO} | | 30 | 45 | | 33 | 50 | | ns |

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|--------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------|
| 5962-8762101EA | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101EA SNJ54LS592J |
| 5962-8762101FA | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| 5962-8762101FA | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| SN54LS592J | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS592J |
| SN54LS592J | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS592J |
| SN54LS592J.A | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS592J |
| SN54LS592J.A | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS592J |
| SN54LS593J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS593J |
| SN54LS593J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS593J |
| SN54LS593J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS593J |
| SN54LS593J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SN54LS593J |
| SN74LS592D | Active | Production | SOIC (D) 16 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS592 |
| SN74LS592D | Active | Production | SOIC (D) 16 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS592 |
| SN74LS592D.A | Active | Production | SOIC (D) 16 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS592 |
| SN74LS592D.A | Active | Production | SOIC (D) 16 | 40 TUBE | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS592 |
| SN74LS592N | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS592N |
| SN74LS592N | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS592N |
| SN74LS592N.A | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS592N |
| SN74LS592N.A | Active | Production | PDIP (N) 16 | 25 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS592N |
| SN74LS592NSR | Active | Production | SOP (NS) 16 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS592 |
| SN74LS592NSR | Active | Production | SOP (NS) 16 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS592 |
| SN74LS592NSR.A | Active | Production | SOP (NS) 16 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS592 |
| SN74LS592NSR.A | Active | Production | SOP (NS) 16 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 74LS592 |
| SN74LS593DW | Obsolete | Production | SOIC (DW) 20 | - | - | Call TI | Call TI | 0 to 70 | LS593 |
| SN74LS593DW | Obsolete | Production | SOIC (DW) 20 | - | - | Call TI | Call TI | 0 to 70 | LS593 |
| SN74LS593DWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS593 |
| SN74LS593DWR | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS593 |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------|
| SN74LS593DWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS593 |
| SN74LS593DWR.A | Active | Production | SOIC (DW) 20 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | LS593 |
| SN74LS593N | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS593N |
| SN74LS593N | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS593N |
| SN74LS593N.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS593N |
| SN74LS593N.A | Active | Production | PDIP (N) 20 | 20 TUBE | Yes | NIPDAU | N/A for Pkg Type | 0 to 70 | SN74LS593N |
| SNJ54LS592J | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101EA SNJ54LS592J |
| SNJ54LS592J | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101EA SNJ54LS592J |
| SNJ54LS592J.A | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101EA SNJ54LS592J |
| SNJ54LS592J.A | Active | Production | CDIP (J) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101EA SNJ54LS592J |
| SNJ54LS592W | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| SNJ54LS592W | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| SNJ54LS592W.A | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| SNJ54LS592W.A | Active | Production | CFP (W) 16 | 25 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | 5962-8762101FA SNJ54LS592W |
| SNJ54LS593J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SNJ54LS593J |
| SNJ54LS593J | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SNJ54LS593J |
| SNJ54LS593J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SNJ54LS593J |
| SNJ54LS593J.A | Active | Production | CDIP (J) 20 | 20 TUBE | No | SNPB | N/A for Pkg Type | -55 to 125 | SNJ54LS593J |

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF SN54LS592, SN54LS593, SN74LS592, SN74LS593 :

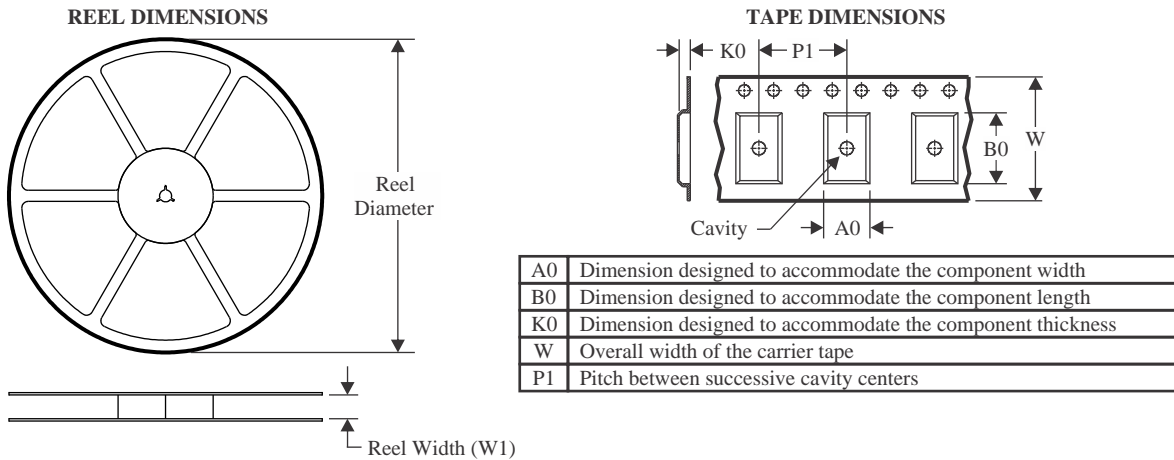
● Catalog : [SN74LS592](#), [SN74LS593](#)

● Military : [SN54LS592](#), [SN54LS593](#)

NOTE: Qualified Version Definitions:

● Catalog - TI's standard catalog product

● Military - QML certified for Military and Defense Applications

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LS592NSR | SOP | NS | 16 | 2000 | 330.0 | 16.4 | 8.1 | 10.4 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LS593DWR | SOIC | DW | 20 | 2000 | 330.0 | 24.4 | 10.8 | 13.3 | 2.7 | 12.0 | 24.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS592NSR | SOP | NS | 16 | 2000 | 353.0 | 353.0 | 32.0 |
| SN74LS593DWR | SOIC | DW | 20 | 2000 | 356.0 | 356.0 | 45.0 |

TUBE


*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-8762101FA | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |
| SN74LS592D | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS592D.A | D | SOIC | 16 | 40 | 507 | 8 | 3940 | 4.32 |
| SN74LS592N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS592N | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS592N.A | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS592N.A | N | PDIP | 16 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS593N | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SN74LS593N.A | N | PDIP | 20 | 20 | 506 | 13.97 | 11230 | 4.32 |
| SNJ54LS592W | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |
| SNJ54LS592W.A | W | CFP | 16 | 25 | 506.98 | 26.16 | 6220 | NA |

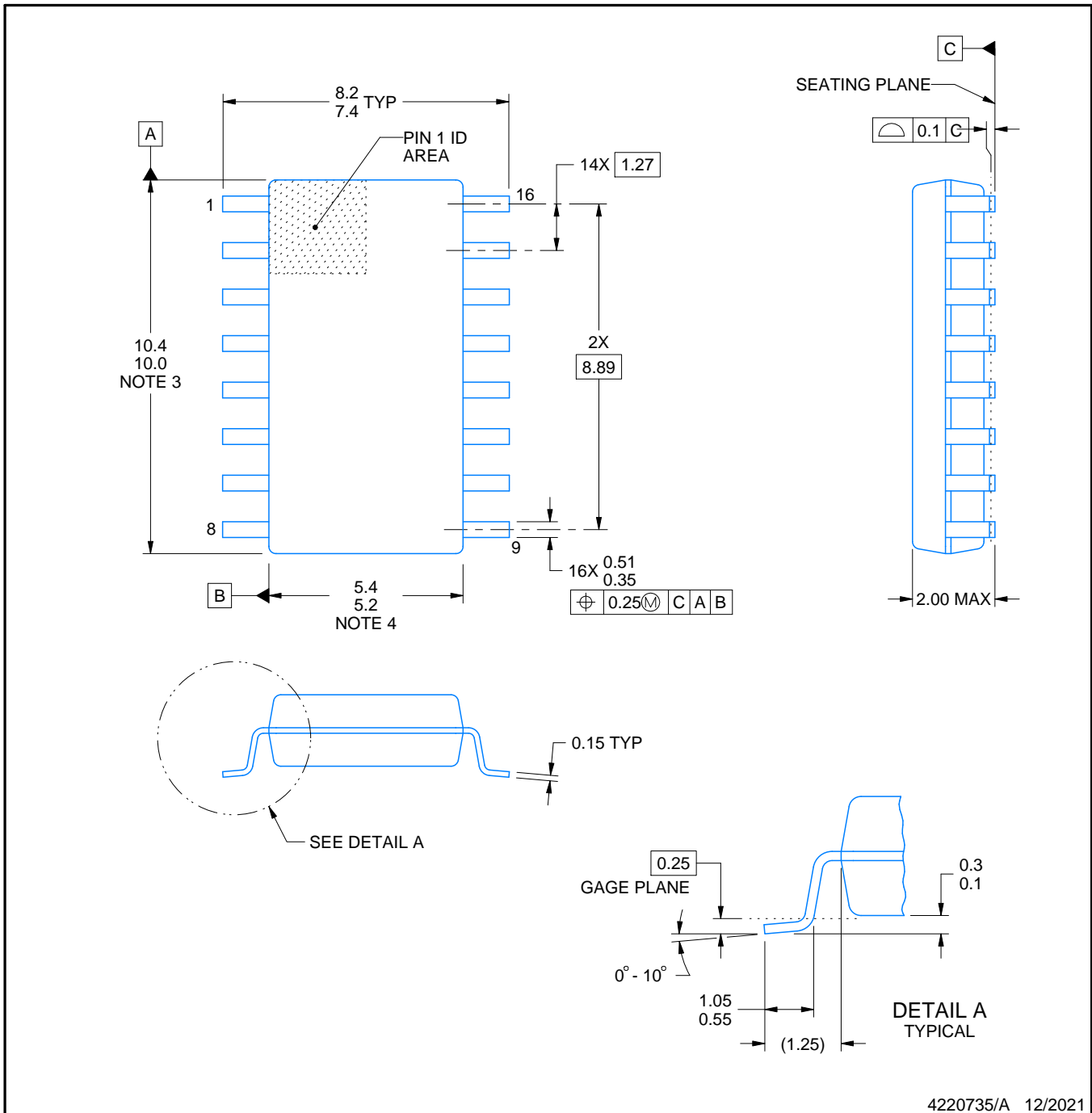


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 -  D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP2-F16

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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